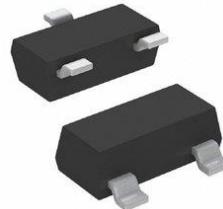


## **WPM6207**

**Single P-Channel, -20V, -5.7A, Power MOSFET**

[www.sh-willsemi.com](http://www.sh-willsemi.com)

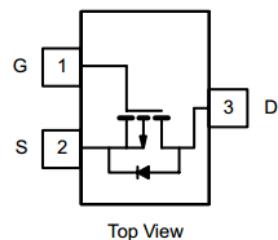
<b>V<sub>DS</sub> (V)</b>	<b>Max R<sub>ds(on)</sub> (mΩ)</b>
<b>-20</b>	32@ V <sub>GS</sub> = - 4.5V
	40@ V <sub>GS</sub> = - 2.5V
	60@ V <sub>GS</sub> = - 1.8V



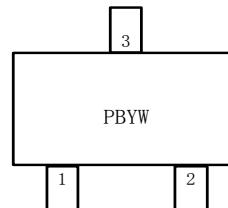
### **Descriptions**

The WPM6207 is P-Channel enhancement MOS Field Effect Transistor. Uses advanced trench technology and design to provide excellent R<sub>DS(ON)</sub> with low gate charge. This device is suitable for use in DC-DC conversion, power switch and charging circuit. Standard Product WPM6207 is Pb-free.

**SOT-23-3**



**Pin configuration (Top view)**



### **Features**

- Trench Technology
- Supper high density cell design
- Excellent ON resistance for higher DC current
- Extremely Low Threshold Voltage
- Small package SOT-23-3

PB= Specific Device Code

Y = Year

W= Week

### **Marking**

### **Order information**

<b>Device</b>	<b>Package</b>	<b>Shipping</b>
WPM6207-3/TR	SOT-23-3	3000/Reel&Tape

### **Applications**

- Power Management in Notebook Computer
- Portable Equipment
- Battery Powered Systems

### Absolute Maximum ratings

Parameter	Symbol	10 S	Steady State	Unit
Drain-Source Voltage	$V_{DS}$	-20		V
Gate-Source Voltage	$V_{GS}$	$\pm 12$		
Continuous Drain Current <sup>a d</sup>	$T_A=25^\circ C$	$I_D$	-6.4	A
	$T_A=70^\circ C$		-5.1	
Maximum Power Dissipation <sup>a d</sup>	$T_A=25^\circ C$	$P_D$	1.5	W
	$T_A=70^\circ C$		1	
Continuous Drain Current <sup>b d</sup>	$T_A=25^\circ C$	$I_D$	-5.5	A
	$T_A=70^\circ C$		-4.4	
Maximum Power Dissipation <sup>b d</sup>	$T_A=25^\circ C$	$P_D$	1.1	W
	$T_A=70^\circ C$		0.7	
Pulsed Drain Current <sup>c</sup>	$I_{DM}$	-20		A
Operating Junction Temperature	$T_J$	-55 to 150		°C
Lead Temperature	$T_L$	260		°C
Storage Temperature Range	$T_{stg}$	-55 to 150		°C

### Thermal resistance ratings

Parameter	Symbol	Typical	Maximum	Unit
Junction-to-Ambient Thermal Resistance <sup>a</sup>	$t \leq 10 s$	$R_{\theta JA}$	65	°C/W
	Steady State		85	
Junction-to-Ambient Thermal Resistance <sup>b</sup>	$t \leq 10 s$	$R_{\theta JA}$	90	
	Steady State		115	
Junction-to-Case Thermal Resistance	Steady State	$R_{\theta JC}$	40	60

a Surface mounted on FR-4 Board using 1 square inch pad size, 1oz copper

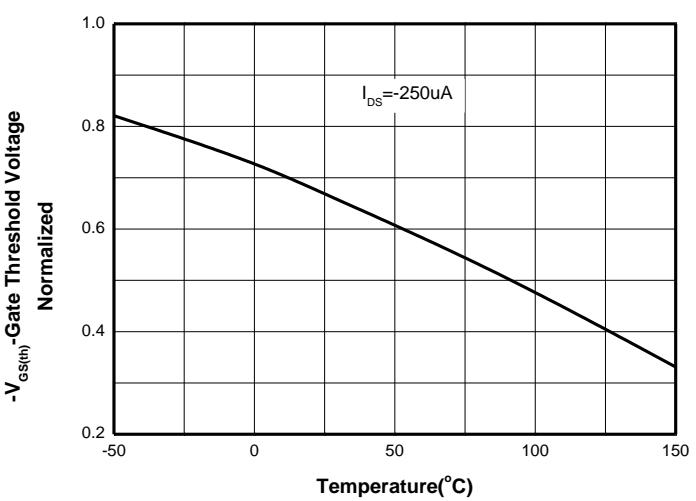
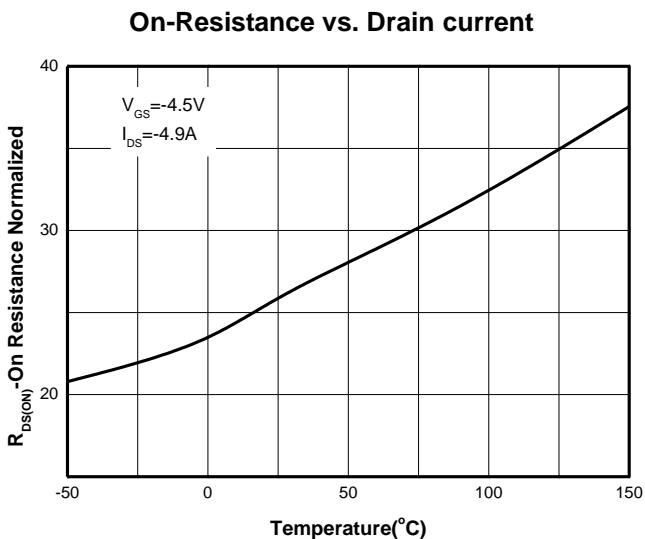
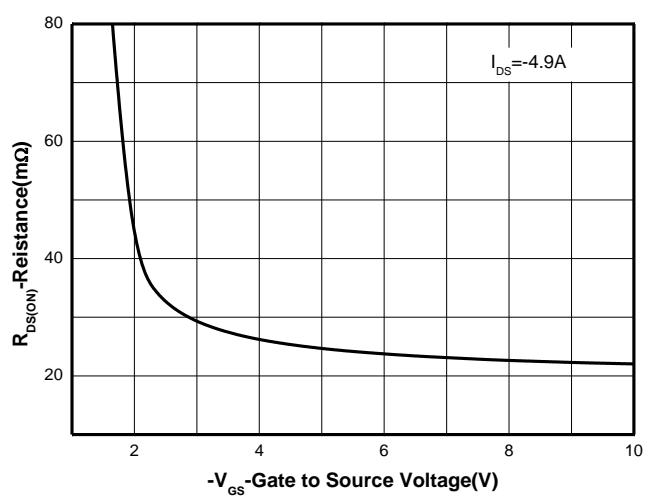
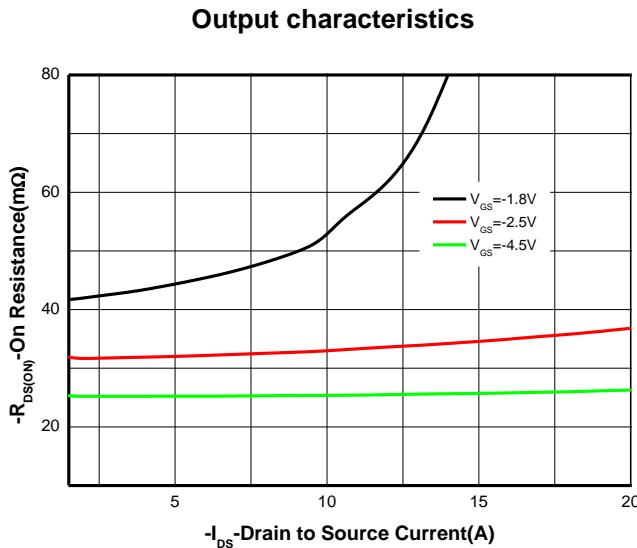
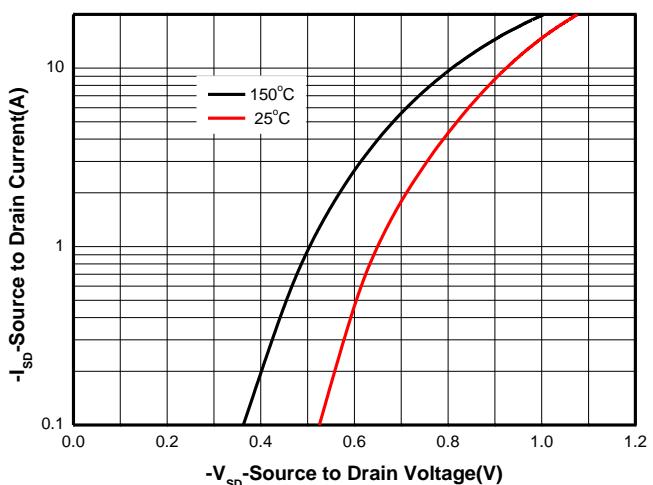
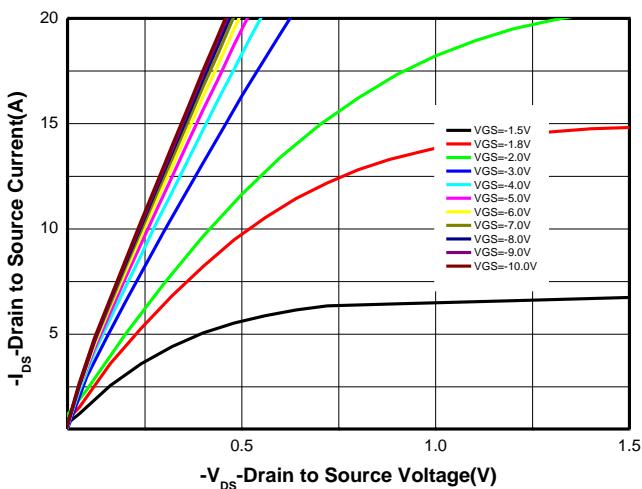
b Surface mounted on FR-4 board using minimum pad size, 1oz copper

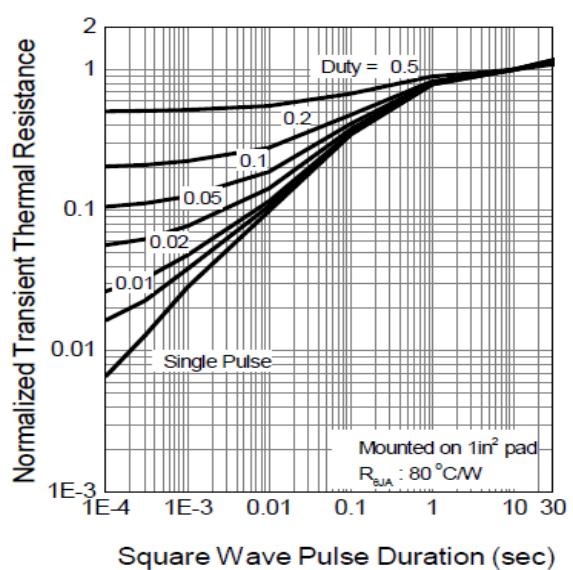
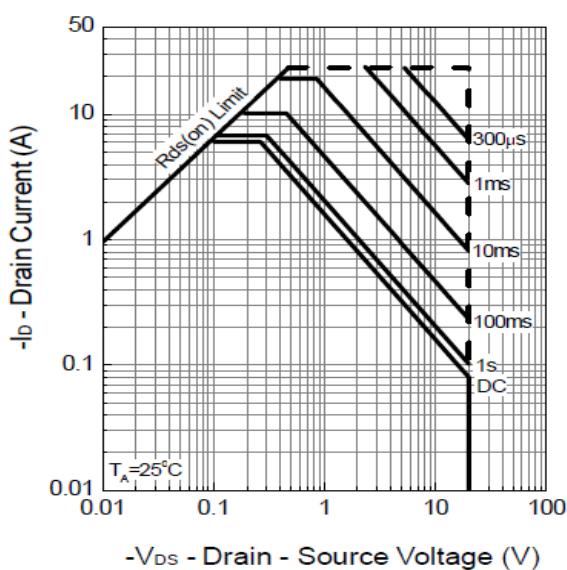
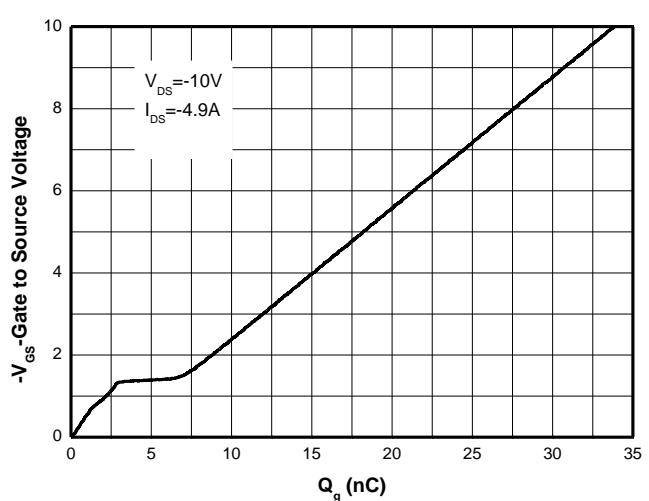
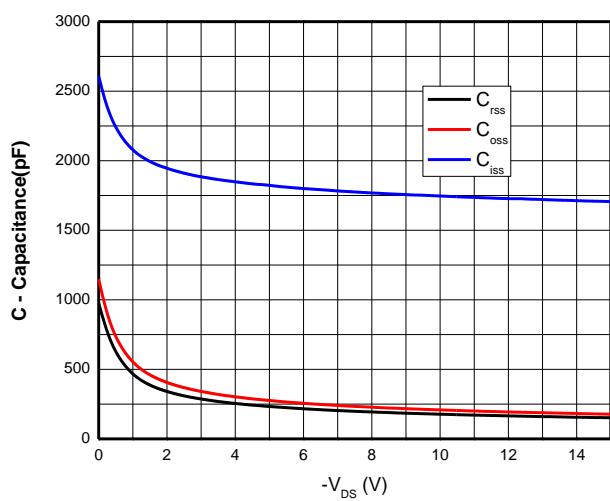
c Pulse width<380μs

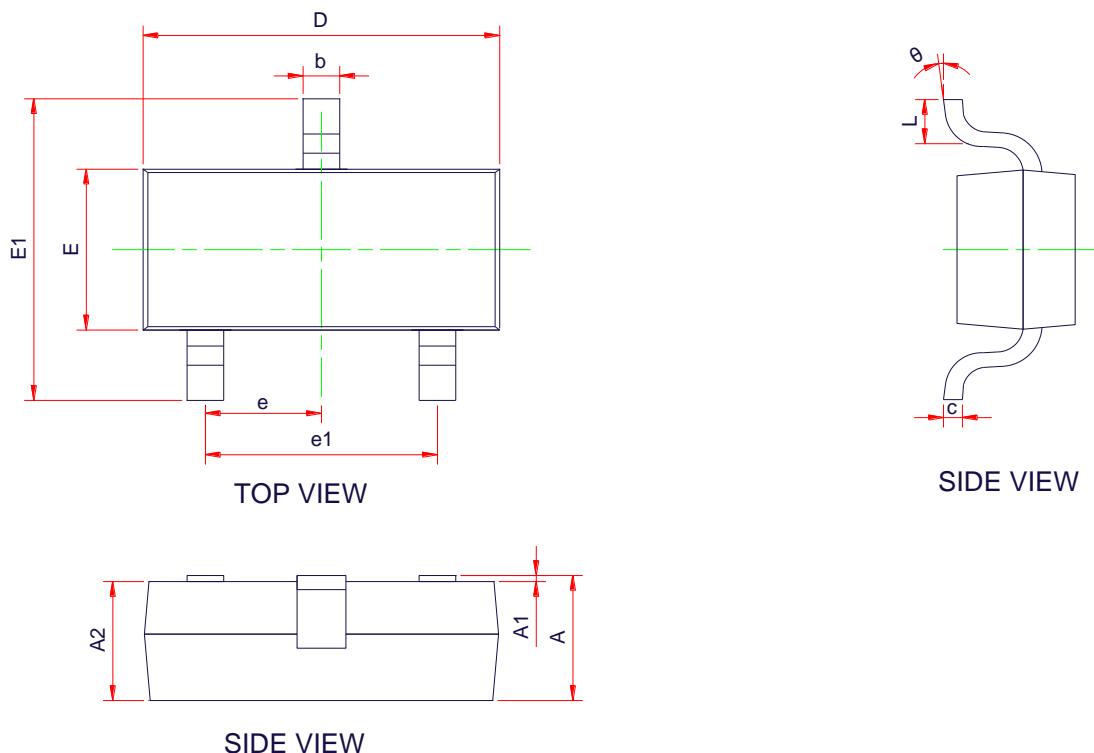
d Maximum junction temperature  $T_J=150^\circ C$ .

**Electronics Characteristics (Ta=25°C, unless otherwise noted)**

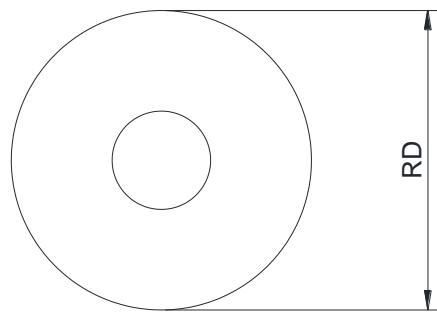
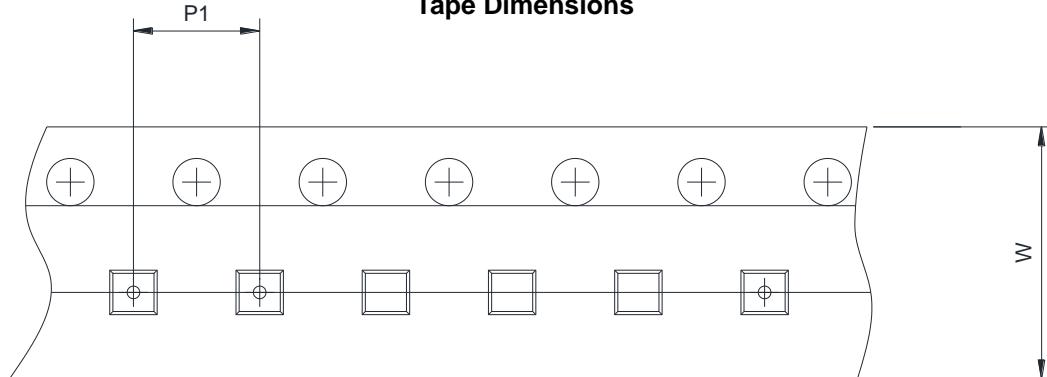
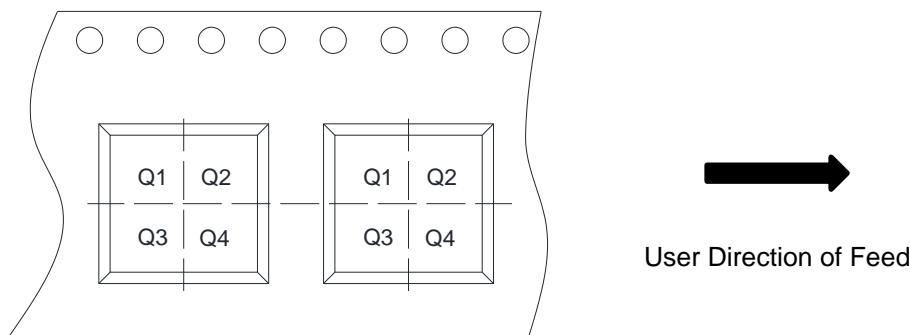
Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
<b>OFF CHARACTERISTICS</b>						
Drain-to-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS} = 0 \text{ V}, I_D = -250\mu\text{A}$	-20			V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = -16\text{V}, V_{GS} = 0\text{V}$			-1	$\mu\text{A}$
Gate-to-source Leakage Current	$I_{GSS}$	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12\text{V}$			$\pm 100$	nA
<b>ON CHARACTERISTICS</b>						
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{GS} = V_{DS}, I_D = -250\mu\text{A}$	-0.4	-0.65	-1	V
Drain-to-source On-resistance <sup>c</sup>	$R_{DS(on)}$	$V_{GS} = -4.5\text{V}, I_D = -5.7\text{A}$		25	32	$\text{m}\Omega$
		$V_{GS} = -2.5\text{V}, I_D = -3.7\text{A}$		32	40	
		$V_{GS} = -1.8\text{V}, I_D = -2.0\text{A}$		42	60	
Forward Transconductance	$g_{FS}$	$V_{DS}=-10\text{V}, I_D=-1.0\text{A}$		6		S
<b>CAPACITANCES, CHARGES</b>						
Input Capacitance	$C_{ISS}$	$V_{GS} = 0 \text{ V},$ $f = 1.0 \text{ MHz},$ $V_{DD} = -10 \text{ V}$		1702		$\text{pF}$
Output Capacitance	$C_{OSS}$			177		
Reverse Transfer Capacitance	$C_{RSS}$			152		
Total Gate Charge	$Q_{G(TOT)}$	$V_{GS} = -4.5 \text{ V},$ $V_{DD} = -10 \text{ V},$ $I_D = -4.9\text{A}$		16.6		$\text{nC}$
Threshold Gate Charge	$Q_{G(TH)}$			0.85		
Gate-to-Source Charge	$Q_{GS}$			2.6		
Gate-to-Drain Charge	$Q_{GD}$			3.9		
<b>SWITCHING CHARACTERISTICS</b>						
Turn-On Delay Time	$td(\text{on})$	$V_{GS} = -4.5 \text{ V},$ $V_{DD} = -10\text{V},$ $I_D=-1\text{A},$ $R_G=6 \Omega$		12.6		$\text{ns}$
Rise Time	$tr$			11.4		
Turn-Off Delay Time	$td(\text{off})$			122		
Fall Time	$tf$			44		
<b>BODY DIODE CHARACTERISTICS</b>						
Forward Voltage	$V_{SD}$	$V_{GS} = 0 \text{ V}, I_S = -2.0\text{A}$			-1.2	V

**Typical Characteristics (Ta=25°C, unless otherwise noted)**




**PACKAGE OUTLINE DIMENSIONS**
**SOT-23-3L**


Symbol	Dimensions in Millimeters		
	Min.	Typ.	Max.
A	-	-	1.25
A1	0.00	-	0.15
A2	1.00	1.10	1.20
b	0.30	0.40	0.50
c	0.10	-	0.20
D	2.82	2.92	3.03
E1	2.60	2.80	3.00
E	1.50	1.62	1.73
e	0.95 BSC		
e1	1.80	1.90	2.00
L	0.30	0.45	0.60
θ	0°	-	8°

**TAPE AND REEL INFORMATION**
**Reel Dimensions**

**Tape Dimensions**

**Quadrant Assignments For PIN1 Orientation In Tape**


<b>RD</b>	<b>Reel Dimension</b>	<input checked="" type="checkbox"/> 7inch <input type="checkbox"/> 13inch
<b>W</b>	<b>Overall width of the carrier tape</b>	<input checked="" type="checkbox"/> 8mm <input type="checkbox"/> 12mm <input type="checkbox"/> 16mm
<b>P1</b>	<b>Pitch between successive cavity centers</b>	<input type="checkbox"/> 2mm <input checked="" type="checkbox"/> 4mm <input type="checkbox"/> 8mm
<b>Pin1</b>	<b>Pin1 Quadrant</b>	<input type="checkbox"/> Q1 <input type="checkbox"/> Q2 <input checked="" type="checkbox"/> Q3 <input type="checkbox"/> Q4

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